

PRELIMINARY

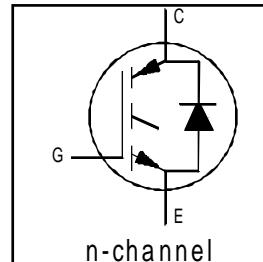
IRG4PC50KD

INSULATED GATE BIPOLEAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Short Circuit Rated
UltraFast IGBT

Features

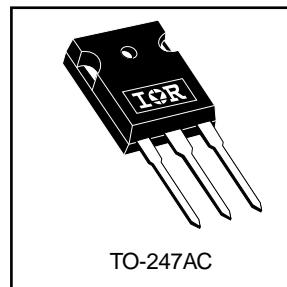
- High short circuit rating optimized for motor control, $t_{sc} = 10\mu s$, @360V V_{CE} (start), $T_J = 125^\circ C$, $V_{GE} = 15V$
- Combines low conduction losses with high switching speed
- Tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultrasoft recovery antiparallel diodes



$V_{CES} = 600V$
 $V_{CE(on)} \text{ typ.} = 1.84V$
 $@V_{GE} = 15V, I_C = 30A$

Benefits

- Latest generation 4 IGBT's offer highest power density motor controls possible
- HEXFRED™ diodes optimized for performance with IGBTs. Minimized recovery characteristics reduce noise, EMI and switching losses
- This part replaces the IRGPC50KD2 and IRGPC50MD2 products
- For hints see design tip 97003



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	52	
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	30	
I_{CM}	Pulsed Collector Current ①	104	
I_{LM}	Clamped Inductive Load Current ②	104	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	25	
I_{FM}	Diode Maximum Forward Current	280	
t_{sc}	Short Circuit Withstand Time	10	
V_{GE}	Gate-to-Emitter Voltage	± 20	
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	104	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	78	
T_J	Operating Junction and Storage Temperature Range	-55 to +150	
T_{STG}	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	$^\circ C$
	Mounting Torque, 6-32 or M3 Screw.	10 lbf•in (1.1 N•m)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	0.64	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case - Diode	—	—	0.83	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	g (oz)

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage ^③	600	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.47	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	1.84	2.2	V	$I_C = 30\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.19	—		$I_C = 52\text{A}$ See Fig. 2, 5
		—	1.79	—		$I_C = 25\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-12	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ^④	17	24	—	S	$V_{\text{CE}} = 100\text{V}$, $I_C = 30\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$
		—	—	6500		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 600\text{V}$, $T_J = 150^\circ\text{C}$
V_{FM}	Diode Forward Voltage Drop	—	1.3	1.7	V	$I_C = 25\text{A}$ See Fig. 13
		—	1.2	1.5		$I_C = 25\text{A}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	
Q_g	Total Gate Charge (turn-on)	—	200	300	nC	$I_C = 30\text{A}$	
Q_{ge}	Gate - Emitter Charge (turn-on)	—	25	38		$V_{\text{CC}} = 400\text{V}$ See Fig.8	
Q_{gc}	Gate - Collector Charge (turn-on)	—	85	127		$V_{\text{GE}} = 15\text{V}$	
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	63	—	ns	$T_J = 25^\circ\text{C}$ $I_C = 30\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$	
t_r	Rise Time	—	49	—			
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	150	220			
t_f	Fall Time	—	95	140			
E_{on}	Turn-On Switching Loss	—	1.61	—	mJ	Energy losses include "tail" and diode reverse recovery See Fig. 9,10,18	
E_{off}	Turn-Off Switching Loss	—	0.84	—			
E_{ts}	Total Switching Loss	—	2.45	3.0			
t_{sc}	Short Circuit Withstand Time	10	—	—	μs	$V_{\text{CC}} = 360\text{V}$, $T_J = 125^\circ\text{C}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 10\Omega$, $V_{\text{CPK}} < 500\text{V}$	
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	61	—	ns	$T_J = 150^\circ\text{C}$, See Fig. 11,18 $I_C = 30\text{A}$, $V_{\text{CC}} = 480\text{V}$ $V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$ Energy losses include "tail" and diode reverse recovery	
t_r	Rise Time	—	46	—			
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	310	—			
t_f	Fall Time	—	170	—			
E_{ts}	Total Switching Loss	—	3.53	—	mJ	Measured 5mm from package	
L_E	Internal Emitter Inductance	—	13	—	nH	$V_{\text{GE}} = 0\text{V}$ $V_{\text{CC}} = 30\text{V}$ See Fig. 7 $f = 1.0\text{MHz}$	
C_{ies}	Input Capacitance	—	3200	—	pF		
C_{oes}	Output Capacitance	—	370	—			
C_{res}	Reverse Transfer Capacitance	—	95	—			
t_{rr}	Diode Reverse Recovery Time	—	50	75	ns	$T_J = 25^\circ\text{C}$ See Fig.	
		—	105	160		$T_J = 125^\circ\text{C}$ 14	
I_{rr}	Diode Peak Reverse Recovery Current	—	4.5	10	A	$T_J = 25^\circ\text{C}$ See Fig.	
		—	8.0	15		$T_J = 125^\circ\text{C}$ 15	
Q_{rr}	Diode Reverse Recovery Charge	—	112	375	nC	$T_J = 25^\circ\text{C}$ See Fig.	
		—	420	1200		$T_J = 125^\circ\text{C}$ 16	
$dI_{(\text{rec})\text{M}}/dt$	Diode Peak Rate of Fall of Recovery During t_b	—	250	—	$A/\mu\text{s}$	$T_J = 25^\circ\text{C}$ See Fig.	
		—	160	—		$T_J = 125^\circ\text{C}$ 17	

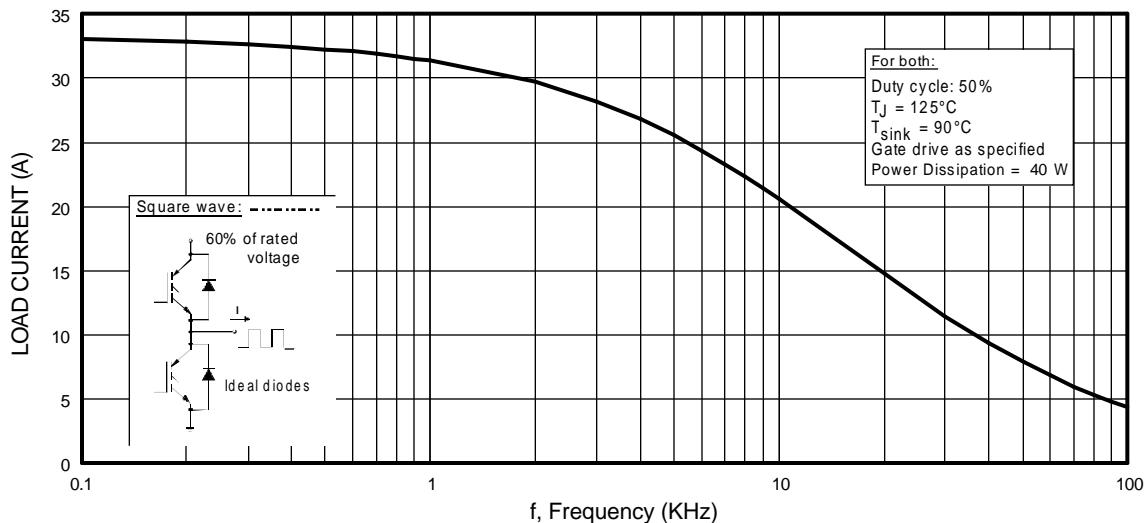


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

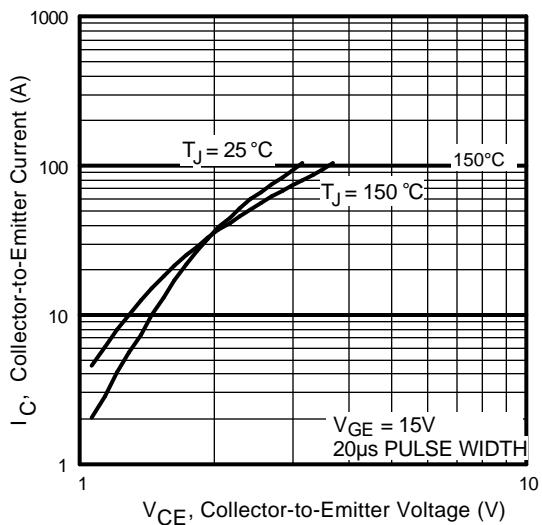


Fig. 2 - Typical Output Characteristics

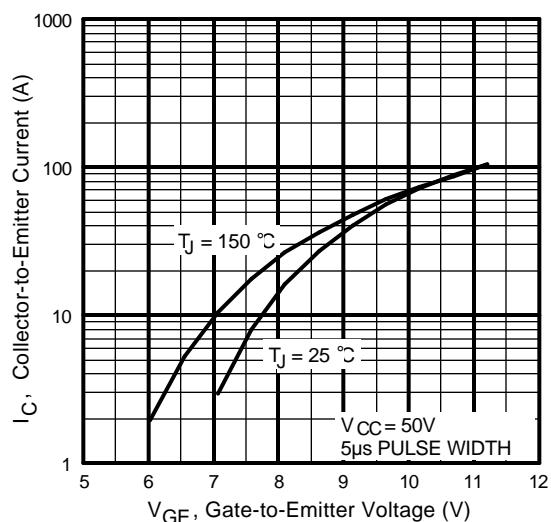


Fig. 3 - Typical Transfer Characteristics

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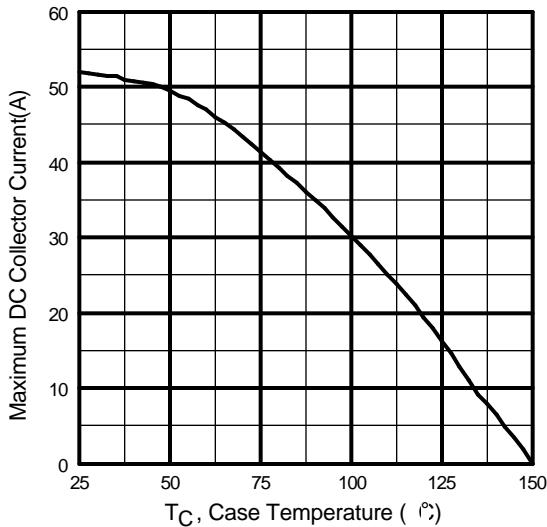


Fig. 4 - Maximum Collector Current vs. Case Temperature

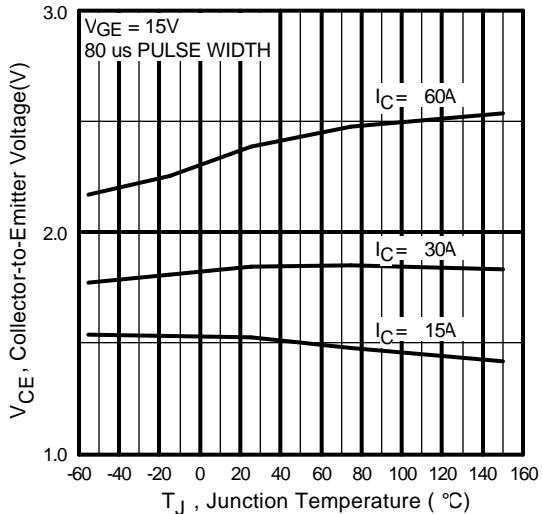


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

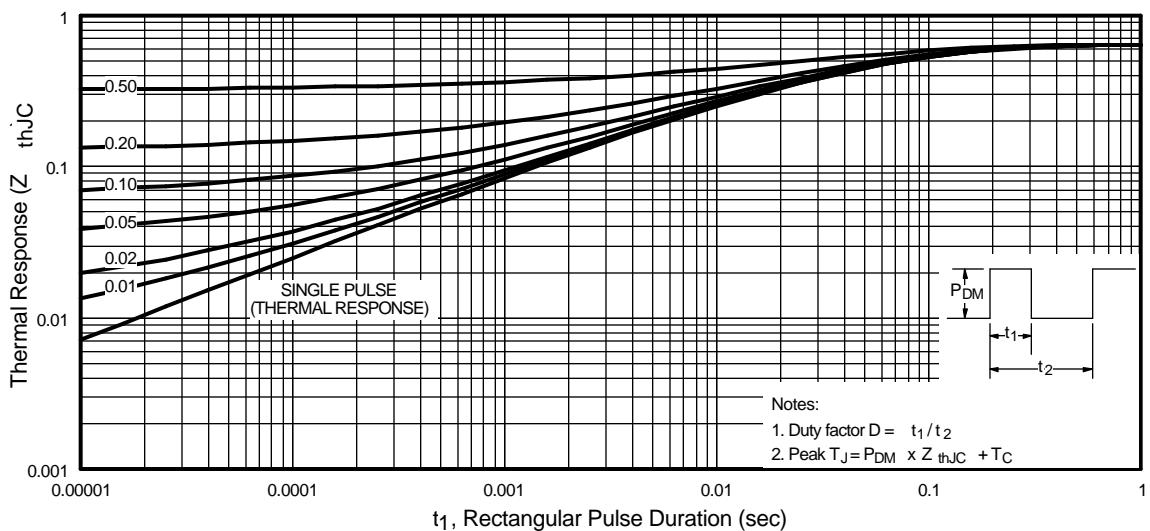
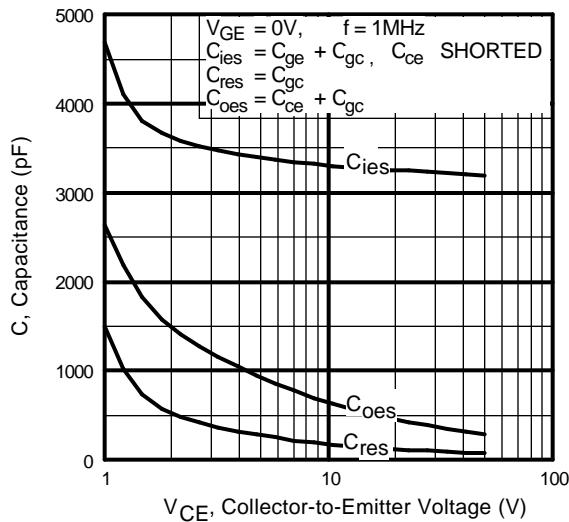
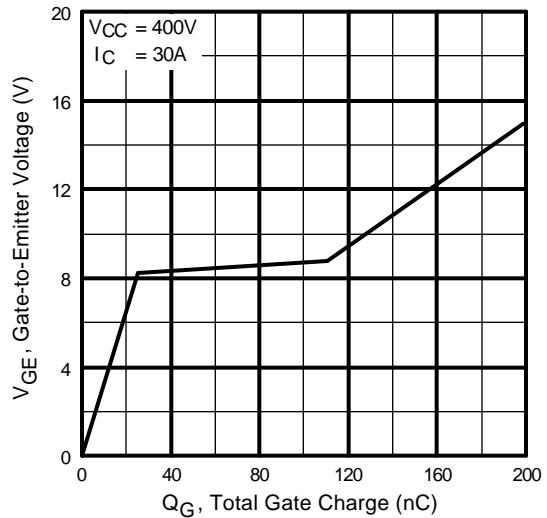


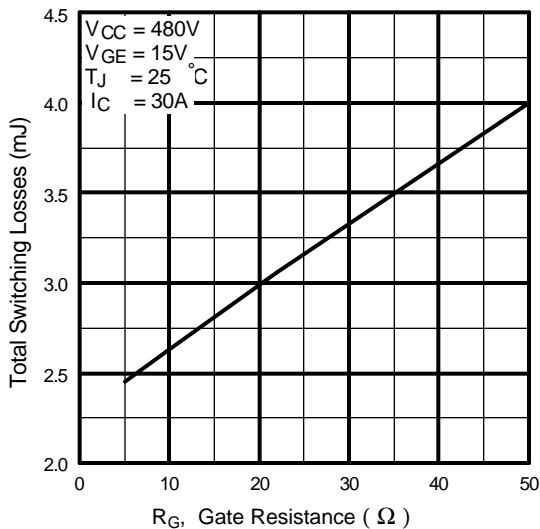
Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



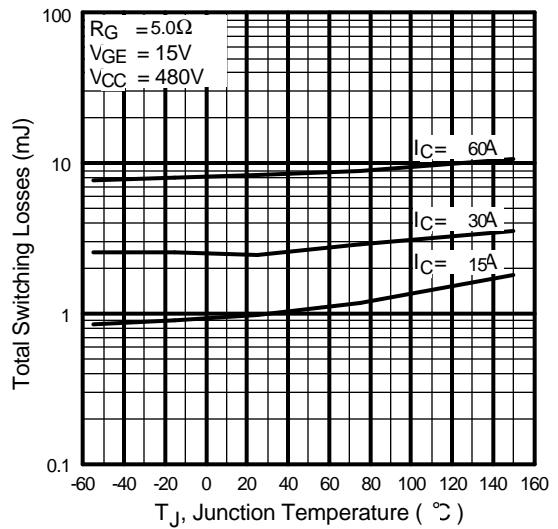
**Fig. 7 - Typical Capacitance vs.
Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.
Gate-to-Emitter Voltage**



**Fig. 9 - Typical Switching Losses vs. Gate
Resistance**



**Fig. 10 - Typical Switching Losses vs.
Junction Temperature**

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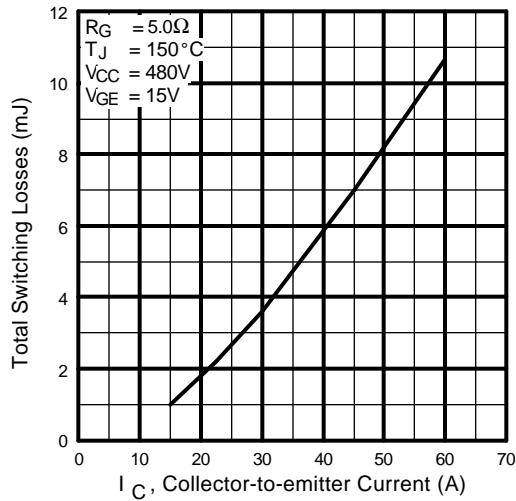


Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current

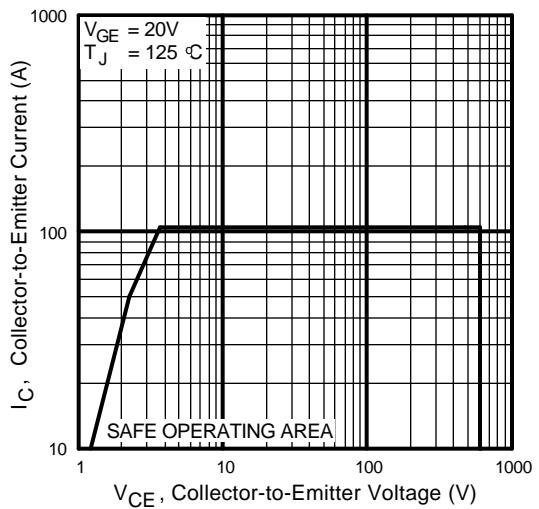


Fig. 12 - Turn-Off SOA

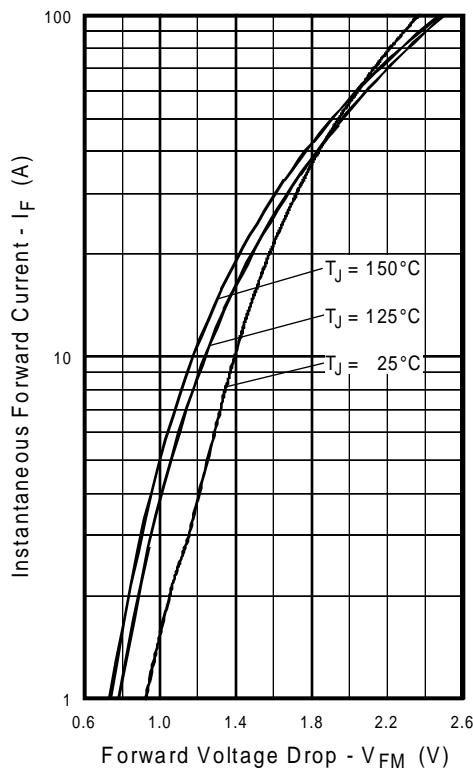


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

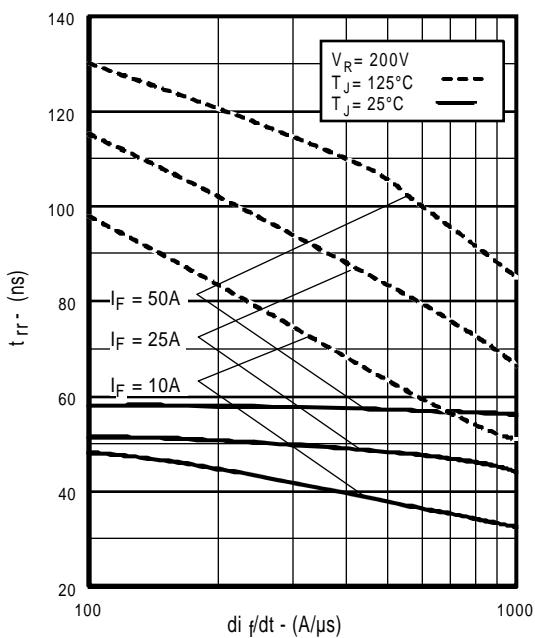


Fig. 14 - Typical Reverse Recovery vs. di_f/dt

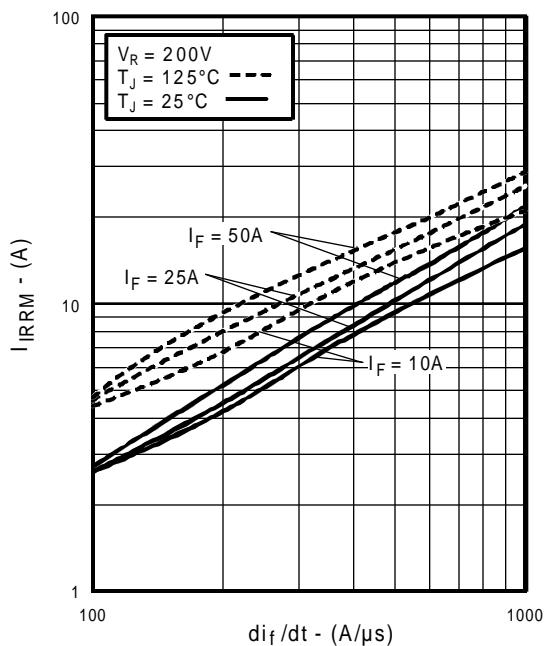


Fig. 15 - Typical Recovery Current vs. di_f/dt

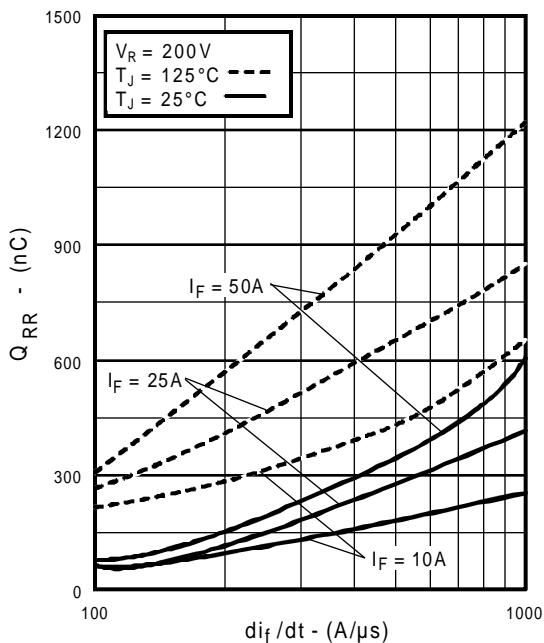


Fig. 16 - Typical Stored Charge vs. di_f/dt

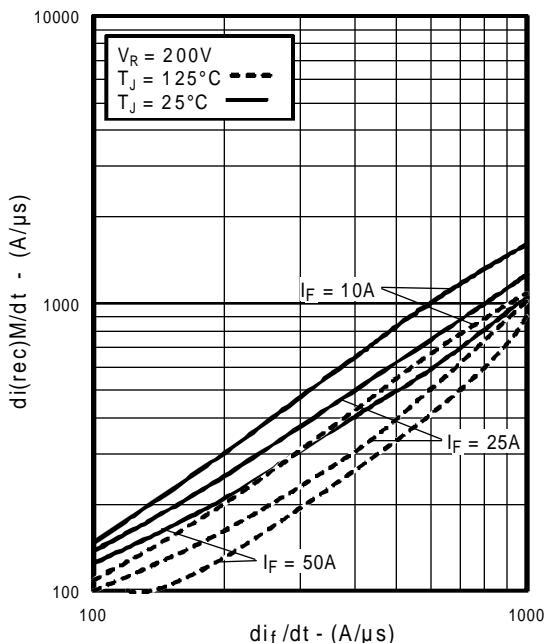


Fig. 17 - Typical $di_{rec}M/dt$ vs. di_f/dt

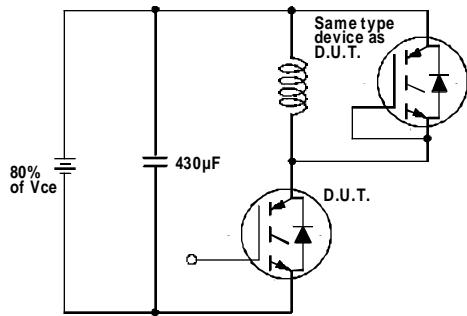


Fig. 18a - Test Circuit for Measurement of I_{LM}, E_{on}, E_{off(diode)}, t_{rr}, Q_{rr}, I_{rr}, t_{d(on)}, t_r, t_{d(off)}, t_f

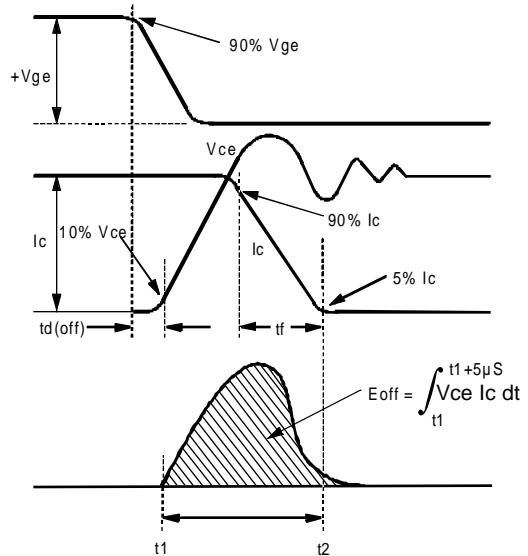


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining E_{off}, t_{d(off)}, t_f

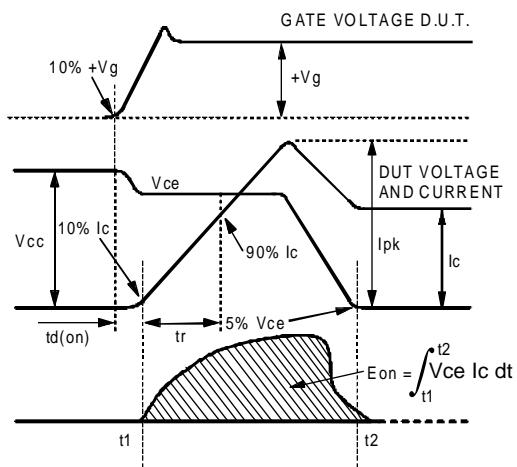


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on}, t_{d(on)}, t_r

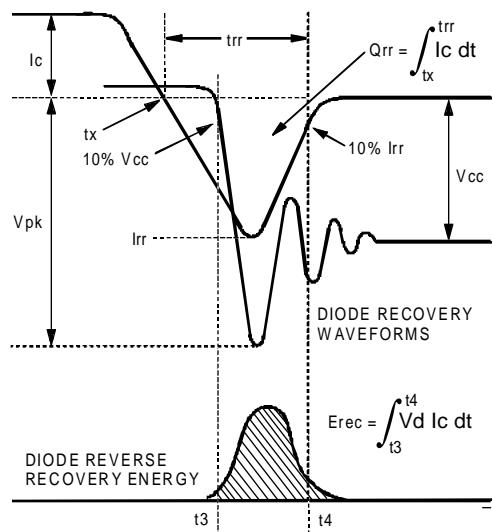


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec}, t_{rr}, Q_{rr}, I_{rr}

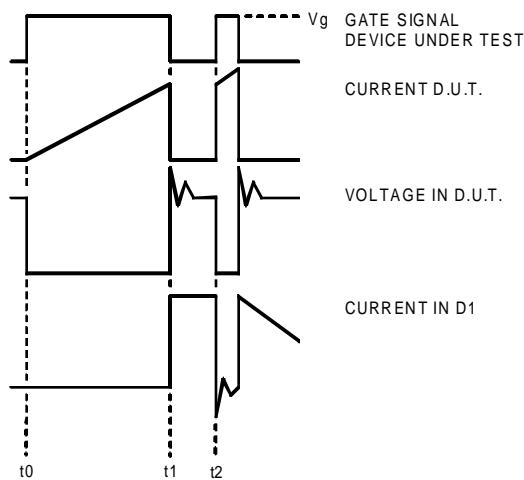


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

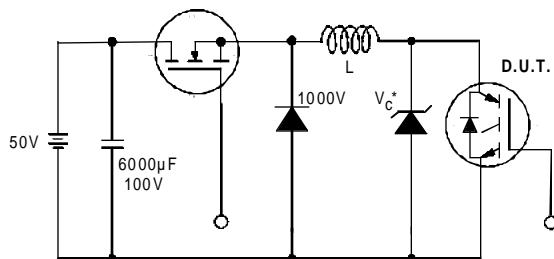


Figure 19. Clamped Inductive Load Test Circuit

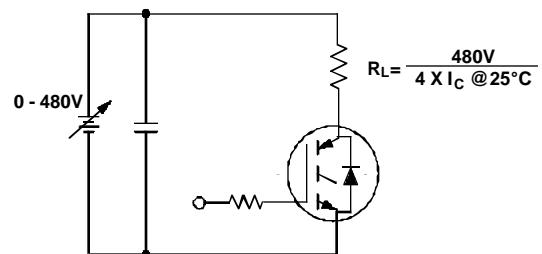
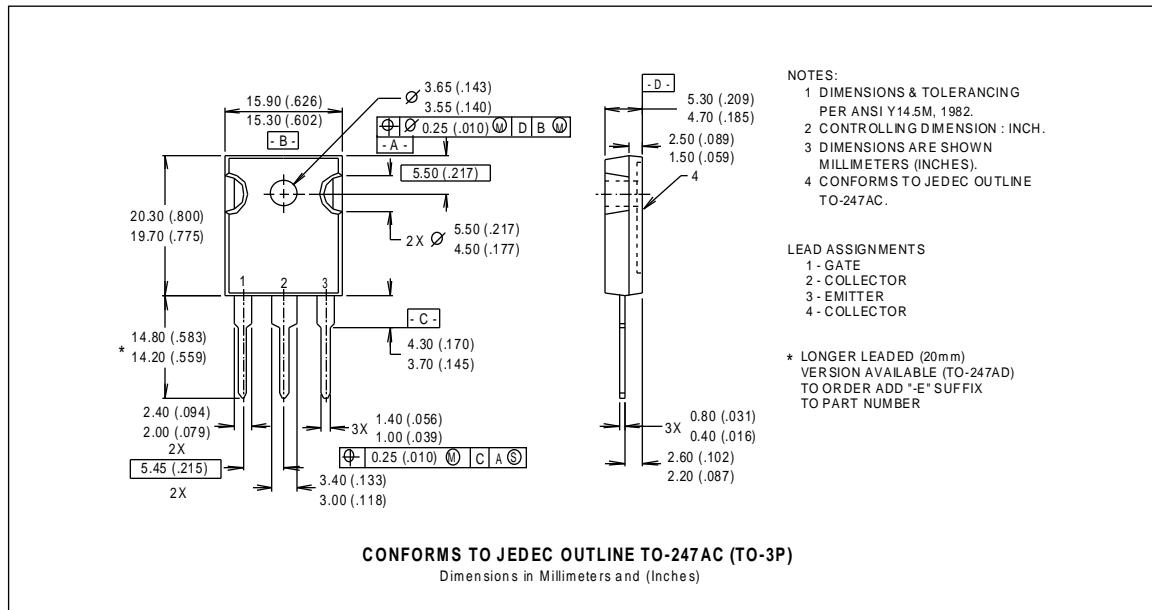


Figure 20. Pulsed Collector Current Test Circuit

Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\% (V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G=5.0\Omega$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ④ Pulse width $5.0\mu s$, single shot.

Case Outline — TO-247AC



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